

# **MBRS130**

### **Features**

- Compact Surface Mount with J-bend Leads (SMB)
- 1.5 Watt Power Dissipation Package
- 1.0 Ampere, Forward Voltage Less than 550mV



# **Schottky Rectifier**

# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	30	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>L</sub> = 120°C	1.0	Α
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current (8.3ms, Single hale sine wave)	40	А
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	-65 to +125	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

### **Thermal Characteristics**

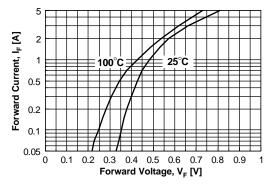
Symbol	Parameter	Value	Units
$R_{\theta JL}$	Thermal Resistance Junctionto Lead	12	°C/W

## Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Max.	Units
V <sub>F</sub>	Forward Voltage	@ I <sub>F</sub> = 1.0A		550	mV
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 30V		1.0	mA
		$V_R = 30V, T_A = 100^{\circ}C$		10	mA

©2004 Fairchild Semiconductor Corporation

# **Typical Characteristics**



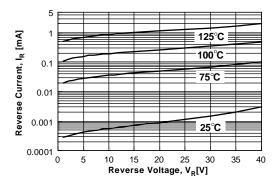


Figure 1. Forward Voltage Characteristics

Figure 2. Reverse Current vs Reverse Voltage

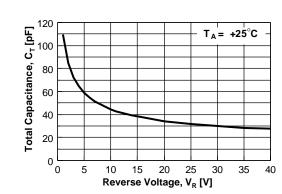


Figure 3. Total Capacitance

### **TRADEMARKS**

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™	FAST <sup>®</sup>	ISOPLANAR™	Power247™	SuperFET™
ActiveArray™	FASTr™	LittleFET™	PowerSaver™	SuperSOT™-3
Bottomless™	FPS™	MICROCOUPLER™	PowerTrench <sup>®</sup>	SuperSOT™-6
CoolFET™	FRFET™	MicroFET™	QFET <sup>®</sup>	SuperSOT™-8
CROSSVOLT™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
DOME™	GTO™	MICROWIRE™	QT Optoelectronics™	TinyLogic <sup>®</sup>
EcoSPARK™	HiSeC™	MSX™	Quiet Series™	TINYOPTO™
E <sup>2</sup> CMOS™	I <sup>2</sup> C™	MSXPro™	RapidConfigure™	TruTranslation™
EnSigna™	i-Lo™	OCX™	RapidConnect™	UHC™
FACT™	ImpliedDisconnect™	OCXPro™	μSerDes™	UltraFET <sup>®</sup>
FACT Quiet Series™	1	OPTOLOGIC <sup>®</sup>	SILENT SWITCHER®	VCX™
Across the board. Ar	ound the world.™	OPTOPLANAR™	SMART START™	
The Power Franchise	_	PACMAN™	SPM™	
Programmable Active	e Droop™	POP™	Stealth™	

#### **DISCLAIMER**

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

### PRODUCT STATUS DEFINITIONS

### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.